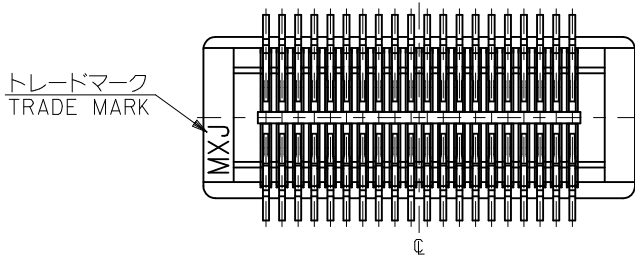


参考基板レイアウト (マウント面)
RECOMMENDED P.C.BOARD
PATTERN DIMENSION (REF.)
(MOUNTING AREA)



注記 NOTES:

1. 使用材料 MATERIAL
ハウジング: 液晶ポリマー ガラス充填 UL94V-0 茶色
HOUSING: LIQUID CRYSTAL POLYMER
GLASS FILLED UL94V-0
COLOR BROWN
ターミナル: リン青銅 (t=0.15)
TERMINAL: PHOSPHOR BRONZE (t=0.15)
2. メッキ仕様 PLATING
金メッキ 0.25 マイクロメートル以上 (コンタクト部)
GOLD 0.25MICROMETER MINIMUM (CONTACT AREA)
金メッキ 0.4 マイクロメートル以下 (テール部)
GOLD 0.4MICROMETER MAXIMUM (TAIL AREA)
下地メッキ: ニッケルメッキ 1.5 マイクロメートル以上
UNDER PLATING: NICKEL 1.5MICROMETER MINIMUM

3. (全極数/2) = 偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN.
4. 嵌合相手: 55526.501017 シリーズ
MATE WITH: 55526.501017 SERIES.
5. テール平坦度は、0.10 MAX.
TAIL COPLANARITY TO BE 0.10 MAX.

30.6	29.6	32.7	54684-1507	150
24.6	23.6	26.7	54684-1207	120
12.6	11.6	14.7	54684-0607	60
10.6	9.6	12.7	54684-0507	50
C	B	A	MATERIAL NO.	CIRCUIT
MODEL NO.			54684-***7	

REVISED EC NO: J2010-2046 DRWN: TARA101 2010/04/13 CHKD: YMIZUNO 2010/04/14 APPR: MSASAO 2010/04/16	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY SAIHARA	DATE 1999/10/02	TITLE 0.4 B-TO-B CONN REC HSG ASSY NO BOSS				
		10 OVER 30 UNDER	±0.25	CHECKED BY YMIZUNO	DATE 2002/03/11	APPROVED BY TYAMAGUCHI 2002/03/11				
		30 OVER	±0.3	MATERIAL NO.		SEE TABLE		DOCUMENT NO. SD-54684-003		
ANGULAR ±3 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
REV		REV		SIZE		SHEET NO.		1 OF 1		